

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3686847

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
WEIZE CHEN	04/13/2012
HUBERT M. BODE	04/17/2012
RICHARD J. DE SOUZA	04/13/2012
PATRICE M. PARRIS	04/13/2012
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	FREESCALE SEMICONDUCTOR, INC.
<b>Street Address:</b>	6501 WILLIAM CANNON DRIVE WEST
<b>City:</b>	AUSTIN
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	78735
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14990765
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	3122910860
<b>Email:</b>	docket-us@lsk-iplaw.com
<b>Correspondent Name:</b>	LEMPIA SUMMERFIELD KATZ LLC
<b>Address Line 1:</b>	20 SOUTH CLARK STREET
<b>Address Line 2:</b>	SUITE 600
<b>Address Line 4:</b>	CHICAGO, ILLINOIS 60603
<b>ATTORNEY DOCKET NUMBER:</b>	AC50647ZP-C01 (11003B)
<b>NAME OF SUBMITTER:</b>	G. CHRISTOPHER BRAIDWOOD
<b>SIGNATURE:</b>	/G. Christopher Braidwood/
<b>DATE SIGNED:</b>	01/08/2016
<b>Total Attachments: 4</b>	
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## ASSIGNMENT AND AGREEMENT

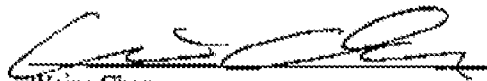
For good and valuable consideration, the receipt of which is hereby acknowledged, we, Weize Chen, Hubert M. Bode, Richard J. De Souza, and Patrice M. Parris, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in a Semiconductor Device with Integrated Breakdown Protection (Docket No. 012668-11003A), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

 Date: 4/13/2012  
Weize Chen


Witness: Marie E Borucki 4/13/2012 MARIE E. BORUCKI

Witness: MD. Mufin-William 4/13/2012 MD M HOQUE

\_\_\_\_\_  
Hubert M. Bode Date: \_\_\_\_\_


Witness: \_\_\_\_\_

Witness: \_\_\_\_\_

 Date: 4/13/2012  
Richard J. De Souza

Witness: Marie E. Borucki 4/13/2012 MARIE E. BORUCKI

Witness: MD. Mufin-William 4/13/2012 MD M HOQUE

 Date: 4/13/2012  
Patrice M. Parris

Witness: Marie E. Borucki 4/13/2012 MARIE E. BORUCKI

Witness: MD. Mufin-William 4/13/2012 MD M HOQUE

PATENT

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PATENT  
REEL: 037436 FRAME: 0473

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..... Date: .....

Weize Chen

Witness : .....

Witness : .....

Hubert M. Bode Date: 17-Apr-2012

Hubert M. Bode

Witness: W. deas Rats

Witness: John Quinn

..... Date: .....

Richard J. De Souza

Witness: .....

Witness : .....

..... Date: .....

Patrice M. Parris

Witness: .....

Witness : .....